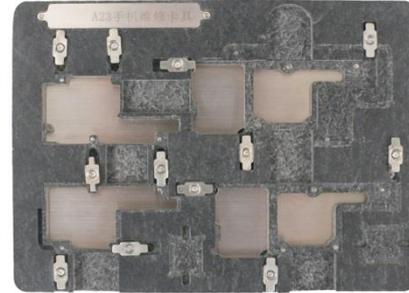


Solder Paste Stencil Station

◆ Product Description

Designed specifically for solder paste stenciling of electronic components, constant temperature heating with precise temperature control, flat and scratch-resistant tabletop, suitable for various specifications of chips, easy to operate, improving stenciling efficiency and success rate.



◆ Product Advantages

- Precise constant temperature (error $\pm 1.5^{\circ}\text{C}$)
- Flat and scratch-resistant tabletop
- Suitable for various specifications of chips
- Easy to operate and get started
- Stable continuous work for $\geq 8\text{h}$

Product Structure

Composed of heating base, constant temperature control panel and non-slip tabletop, built-in temperature control chip, the tabletop can be fine-tuned in angle, compact structure and stable placement

◆ Application Scenarios

Suitable for solder paste stenciling and repair of chips in digital products such as mobile phones and tablets, matching BGA, QFP and other packaged chips, it is a core auxiliary equipment for electronic repair shop

◆ Technical Features

Material: Forged 40Cr alloy steel (zinc-plated for rust resistance)

Hardness: HRC48–52

Dimensions: 145mm (L) \times 7.8mm (D)

Load Capacity: $\leq 48\text{kg}$

Corrosion Resistance: Salt spray test $\geq 48\text{h}$ (no rust)

Core Features: One-piece construction, high hardness & wear resistance, zinc-plated rustproof, smooth scratch-resistant edges, labor-saving operation

material code	weight	manner of packing
1.5.19.03.0024	0.46	One per box
1.5.19.03.0025	0.38	One per box
1.5.19.03.0026	0.38	One per box

◆ Remarks

HORB has a technical hotline for technical and usage inquiries. This information is deemed accurate, for professional end users only. HORB data is for reference.

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